

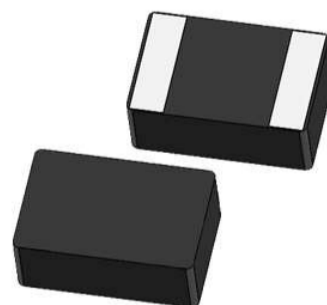
◆ Scope

This specification applies to the SLO252010T Series of SMD power inductors.

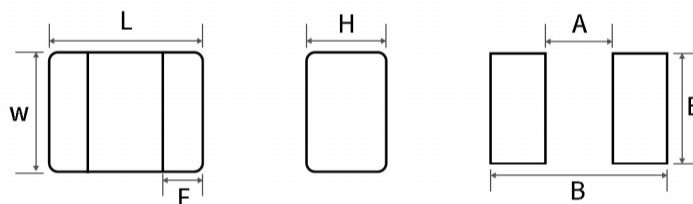
◆ Lead Free Part Numbering

SLO	252010	T	1R0	M	T	T
(1)	(2)	(3)	(4)	(5)	(6)	(7)

- (1) Series Type
- (2) Dimension: LxWxH
- (3) Material Code
- (4) Inductance: R68=0.68uH; 1R0=1.0uH
- (5) Inductance Tolerance: M=±20%, N=±30%
- (6) Company Code
- (7) Packaging: packed in embossed carrier tape

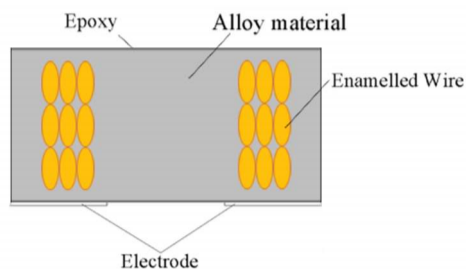


◆ Dimensions



Series	L(mm)	W(mm)	H(mm)	F(mm)	Recommended Land Patterns		
					A(mm)	B(mm)	E(mm)
SLO252010T	2.5±0.2	2.0±0.2	1.0Max.	0.9Typ.	1.0Typ.	2.8Typ.	2.1Typ.

◆ Structural drawing



No.	Component	Material
①	Body	Alloy material
②	Winding	Enamelled Wire
③	Shield	Epoxy
④	Electric	Base plating-Cu Base plating-Ni Base plating-Sn

◆ Specification

Part No.	Inductance Ls(uH)	Direct Current Resistance DCR(mΩ)		Saturation Current Isat(A)		Temperature Rise Current Irms(A)	
		Max.	Typ.	Max.	Typ.	Max.	Typ.
SLO252010TR22MTT	0.22±20%	17	12	7.90	8.70	6.50	6.80
SLO252010TR24MTT	0.24±20%	18	12	7.90	8.60	6.50	6.90
SLO252010TR33MTT	0.33±20%	19	13	7.30	7.60	6.30	6.50
SLO252010TR47MTT	0.47±20%	22	15	6.60	6.90	5.70	6.20
SLO252010TR68MTT	0.68±20%	27	22	5.60	5.90	5.10	5.70
SLO252010T1R0MTT	1.0±20%	30	25	4.90	5.30	4.20	4.50
SLO252010T1R5MTT	1.5±20%	55	45	3.90	4.30	3.10	3.40
SLO252010T2R2MTT	2.2±20%	70	62	3.10	3.30	2.20	2.40
SLO252010T3R3MTT	3.3±20%	100	86	2.50	2.90	2.20	2.50
SLO252010T4R7MTT	4.7±20%	180	160	2.10	2.60	1.70	2.00
SLO252010T6R8MTT	6.8±20%	320	270	1.90	2.40	1.40	1.60
SLO252010T100MTT	10±20%	560	500	1.40	1.55	0.95	1.05
SLO252010T220MTT	22±20%	1300	1100	0.90	1.15	0.60	0.90

Test condition & equipment :

Item	Test condition	Test equipment
Ls	1MHz/1V	HP4263BIM3532-50 or equivalent
DCR	direct-current	HP4263BRM3545 or equivalent
Isat	1MH/1V	Microtest 6379 &6220 or equivalent
Irms	ambient temperature 20°C	Microtest 6379 &6220 or equivalent

Isat: The DC current at which the inductance drops approximate 30%from its value without current, Load current time within Ls.

Irms: The DC current is inductor surface temperature to rise by 40°C.

◆ Operating Temperature Range

-40°C~+125°C,Including self-heating

◆ Storage Conditions

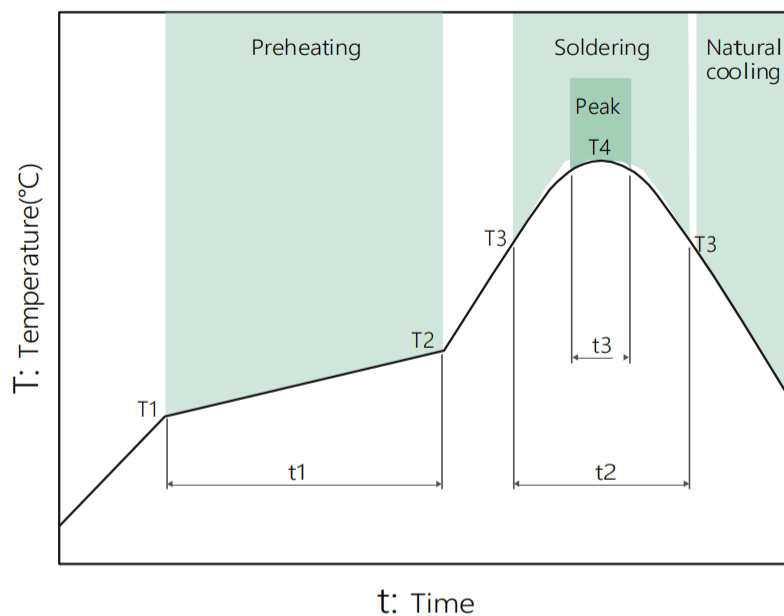
Store products in a warehouse in compliance with the following condition:

Temperature: Inductors (product with taping) -10 to +40°C;

Inductors body -40 to +85°C.

Humidity: 30~70%RH

◆ RECOMMENDED REFLOW PROFILE



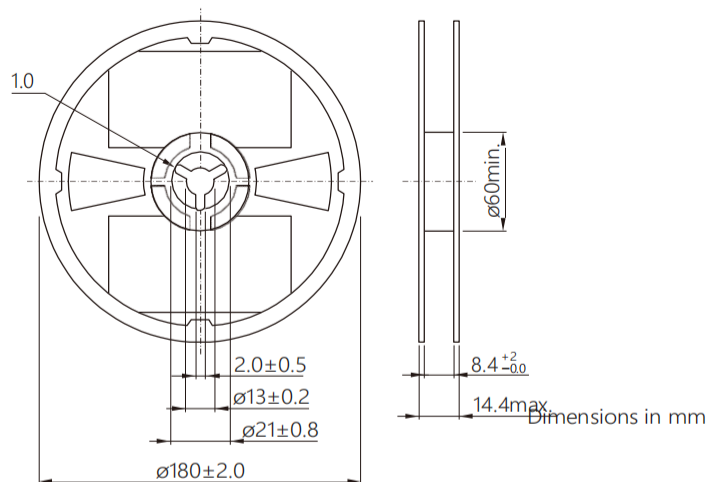
Preheating			Soldering		Peak	
Temp.		Time	Temp.	Time	Temp.	Time
T1	T2	t1	T3	t2	T4	t3
150°C	180°C	60 to 120s	230°C	30 to 50s	250 to 260°C	10s max

◆ Reliability Mechanical

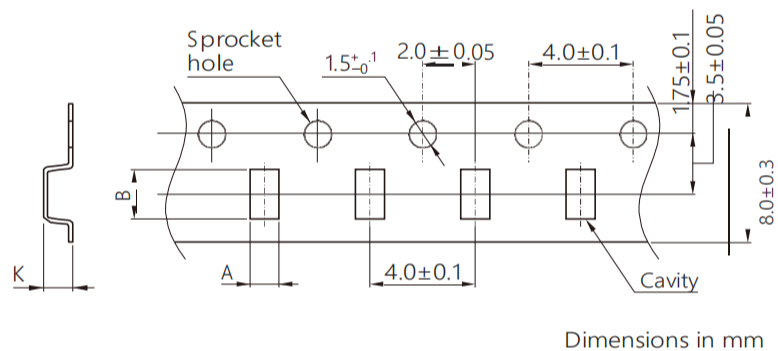
序号 No.	项目 Items	要求 Requirements	试验方法及备注 Test Methods and Remarks
1	绝缘电阻 Insulation Resistance	$\geq 100\text{M}\Omega$	在电感器线圈和本体顶面中间施加 100 V 直流电压保持60 s。 100 V DC between inductor coil and The middle of the top surface of the body for 60 seconds.
2	可焊性 Solderability	电极面90%以上覆盖新的焊料。 90% or more of electrode area shall be coated by new solder.	在 $(245\pm 5)^{\circ}\text{C}$ 熔融的焊锡 (96.5Sn/3.0Ag/0.5Cu) 中浸 (5 ± 1) s。 Dip pads in flux and dip in solder pot (96.5Sn/3.0Ag/0.5Cu) at $(245\pm 5)^{\circ}\text{C}$ for (5 ± 1) seconds.
3	耐焊接热 Resistance to Soldering Heat	外观无可见机械损伤; 电感量变化率: $\pm 10\%$ 以内。 No visible mechanical damage. Inductance change: Within $\pm 10\%$	在 $(260\pm 5)^{\circ}\text{C}$ 熔融的焊锡 (96.5Sn/3.0Ag/0.5Cu) 中浸 (10 ± 1) s。 Dip pads in flux and dip in solder pot (96.5Sn/3.0Ag/0.5Cu) at $(260\pm 5)^{\circ}\text{C}$ for (10 ± 1) seconds.
4	端子强度 Adhesion of terminal electrode	元件的端子与本体结合无松动、无脱落。 Strong bond between the pad and the core, without come off PC board.	将电感器用 $(260\pm 5)^{\circ}\text{C}$, (20 ± 5) s 焊在带有 0.3 mm 厚锡膏的基板上, 然后用治具垂直电极面方向加压 10 N, (10 ± 1) s。 Inductors shall be subjected to $(260\pm 5)^{\circ}\text{C}$ for (20 ± 5) s Soldering in the base whit 0.3mm solder. And then aplomb electrode way plus tax 10 N for (10 ± 1) seconds.
5	耐高温 High temperature	外观无可见机械损伤; 电感量变化率: $\pm 10\%$ 以内。 No visible mechanical damage. Inductance change: Within $\pm 10\%$	温度 $(+85\pm 2)^{\circ}\text{C}$, 时间 (96 ± 2) h; Temperature is $(+85\pm 2)^{\circ}\text{C}$ and keep (96 ± 2) hours.
6	耐低温 Low temperature	外观无可见机械损伤; 电感量变化率: $\pm 10\%$ 以内。 No visible mechanical damage. Inductance change: Within $\pm 10\%$	温度 $(-40^{\circ}\text{C} \pm 2)^{\circ}\text{C}$, 时间 (96 ± 2) h; Temperature is $(-40\pm 2)^{\circ}\text{C}$ and keep (96 ± 2) hours.

序号 No.	项目 Items	要求 Requirements	试验方法及备注 Test Methods and Remarks
7	温度变化 Thermal shock	外观无可见机械损伤；电感量变化率：±10%以内。 No visible mechanical damage. Inductance change: Within ±10%	(-40±3) °C, 时间(30±3) min ↔ (125±2) °C/(30±3) min, 转换时间(2~3) min, 循环32次；在室温下放置 2 小时后、48 小时内测试。 The test sample shall be placed at (-40±3)°C and (125±2)°C for (30±3) min, different temperature conversion time is 2~3 minutes. The temperature cycle shall be repeated 32 cycles. Placed at room temperature for 2 hours, within 48 hours of testing.
8	温度特性 Temperature characteristic	电感量变化率 P_{c-b}, P_{c-d} 不超过 ±20%。 Inductance change P_{c-b}, P_{c-d} : Within ±20%	a: +20 °C (30~45) min → b: -40 °C (30~45) min → c: +20 °C (30~45) min → d: +125 °C (30~45) min → e: +20 °C (30~45) min $P_{c-b} = \frac{L_b - L_c}{L_c} \times 100\% ; \quad P_{c-d} = \frac{L_d - L_c}{L_c} \times 100\%$
9	恒定湿热 Static Humidity	外观无可见机械损伤； 电感量变化率：±10%以内。 No visible mechanical damage. Inductance change: Within ±10%	将电感器放置在于湿度(93±3)%RH, 温度(40±2) °C 的环境中存放(1000±2) h, 在室温下放置2 小时后、48 小时内测试。 Inductors shall be subjected to (93±3)%RH . at (60±2)°C for (96±2) h . Placed at room temperature for 2 hours, within 48 hours of testing.
10	耐久性 (寿命) Life	外观无可见机械损伤； 电感量变化率：±10%以内。 No visible mechanical damage. Inductance change: Within ±10%	温度(85±2)°C, 时间(1000±24) h, 施加Irms, 在室温下放置2 小时后、48 小时内测试。 Inductors shall be store at (85±2)°C for (1000±24) hours with Irms applied. Placed at room temperature for 2 hours, within 48 hours of testing.

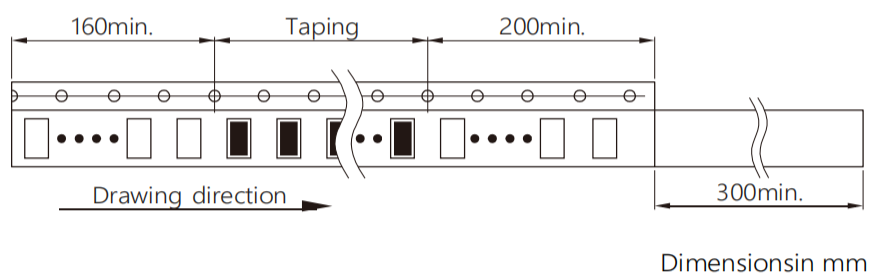
◆ Taping reel dimensions



◆ Carrier tape dimensions



Series Type	A	B	K
SLO252010T	2.2	2.7	1.3



◆ Package quantity

Package quantity	3000 pcs/reel
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